

AUX015-1106

SEMI OCR CHARACTER OUTLINES

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NOTE: The material in this Auxiliary Information is referenced by documents in the SEMI Standards Materials and Traceability volumes. It replaces appendices in SEMI M12, SEMI M13, and SEMI T5.

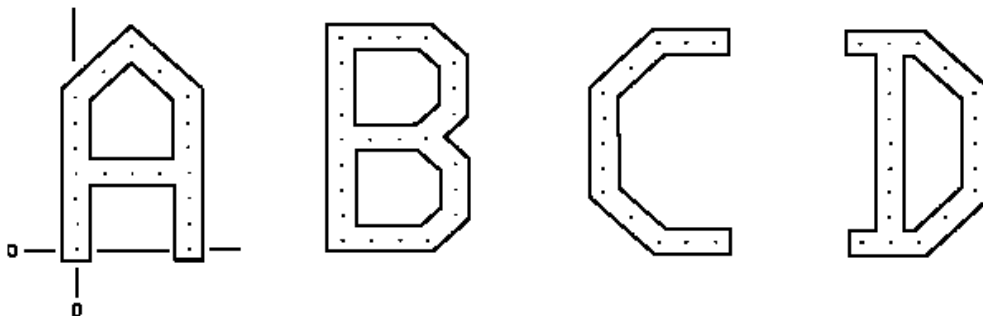
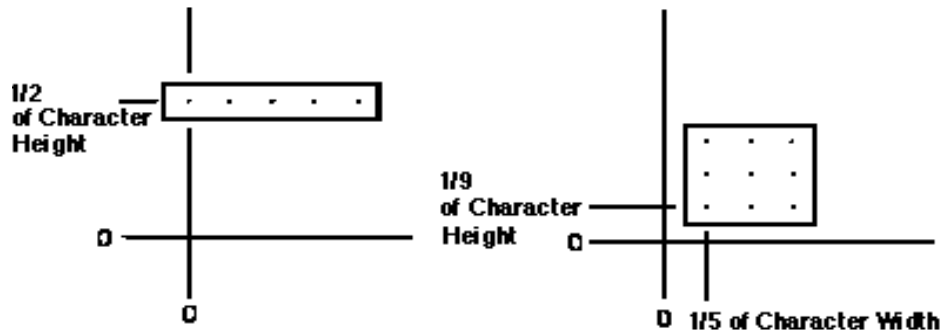
1 SEMI OCR Character Set

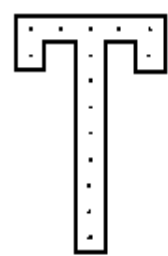
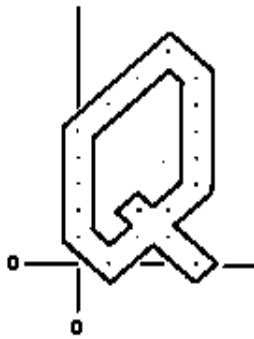
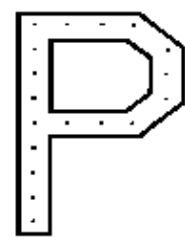
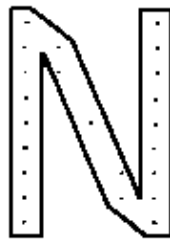
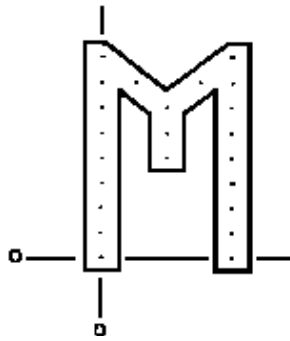
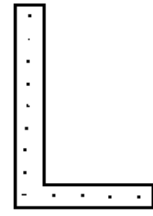
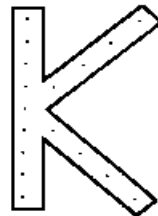
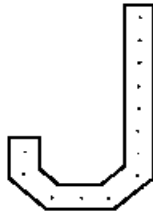
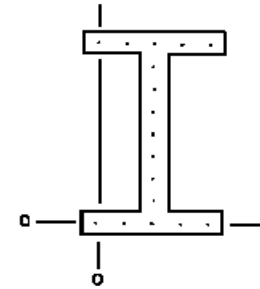
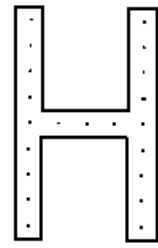
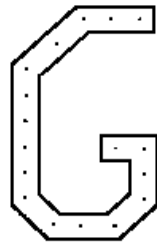
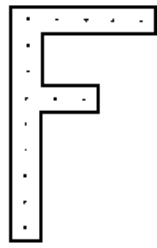
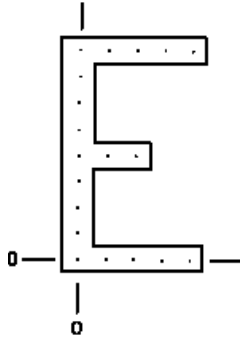
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 P Q R S T U V W X Y Z -
 0 1 2 3 4 5 6 7 8 9 .

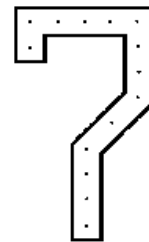
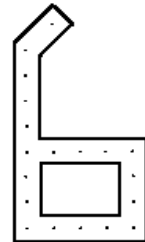
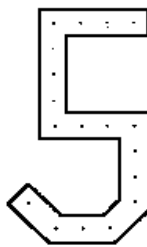
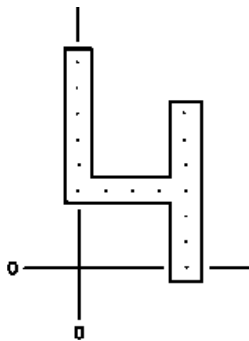
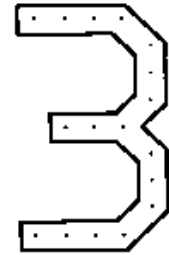
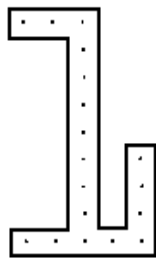
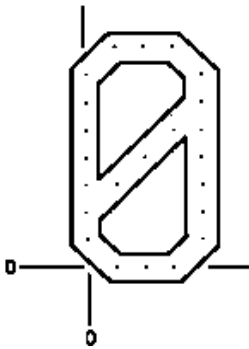
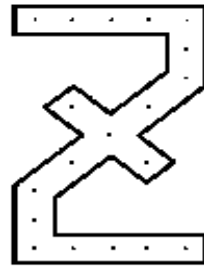
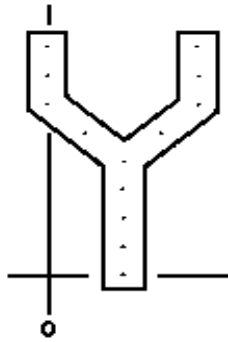
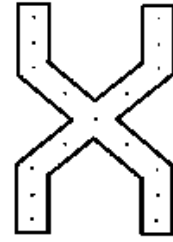
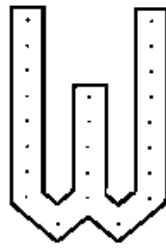
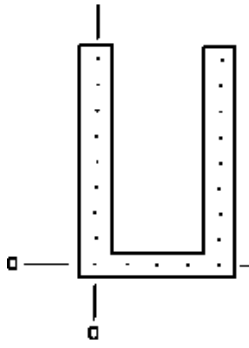
Figure 1
 SEMI OCR Character Set

2 Dot Matrix Format

2.1 The following show the SEMI-OCR font in “single-density” mode, using a dot matrix of 5 dots horizontal and 9 dots vertical.







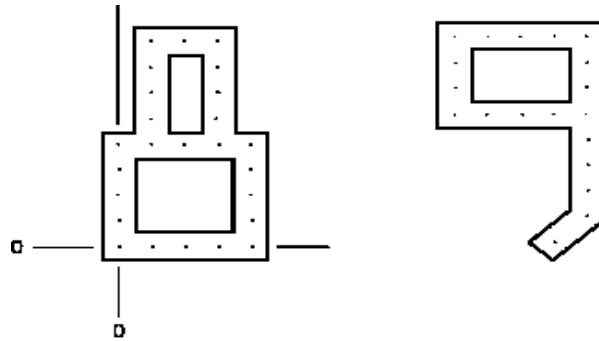
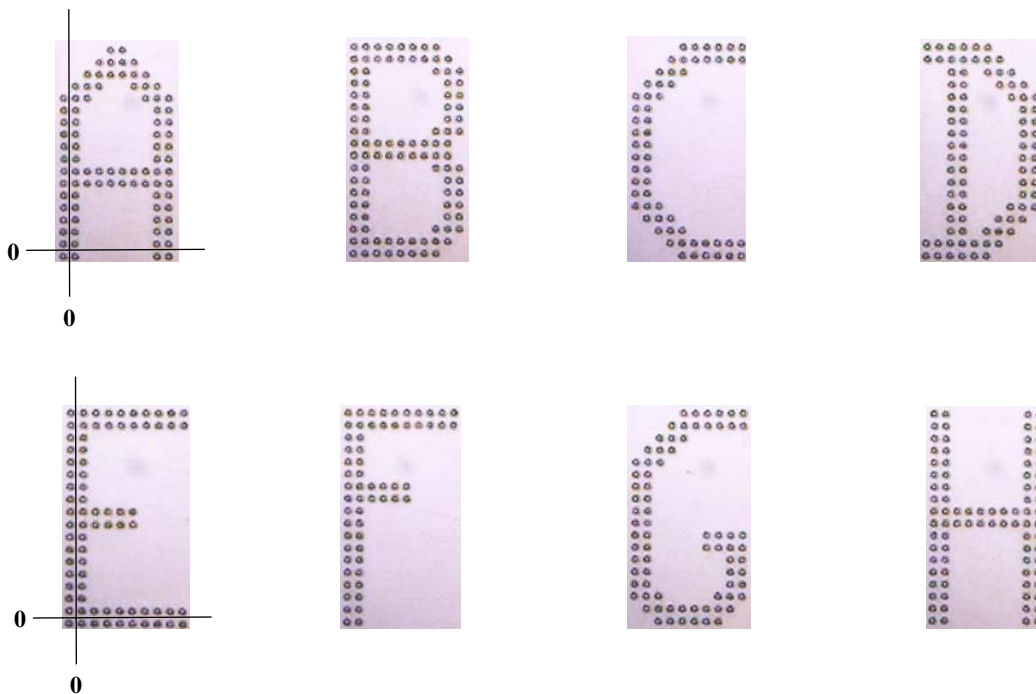
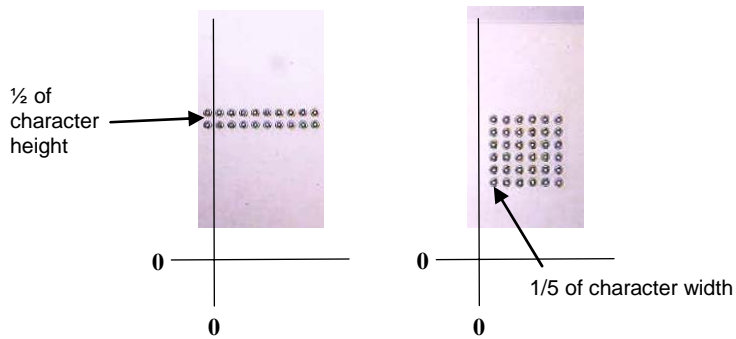
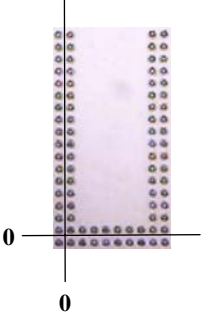
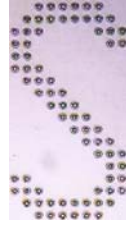
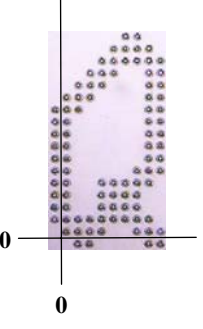
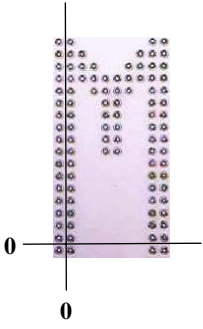
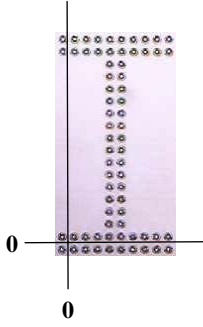


Figure 2
Single Density SEMI OCR Character Outlines

2.2 The following show the SEMI-OCR font in “double-density” mode, using a dot matrix of 10 dots horizontal and 18 dots vertical.

NOTE 1: The “origin” of this matrix is denoted by the intersection of the “0-0” lines. It is centered among four dots. Single-density mode places the matrix origin at the center of a single dot.





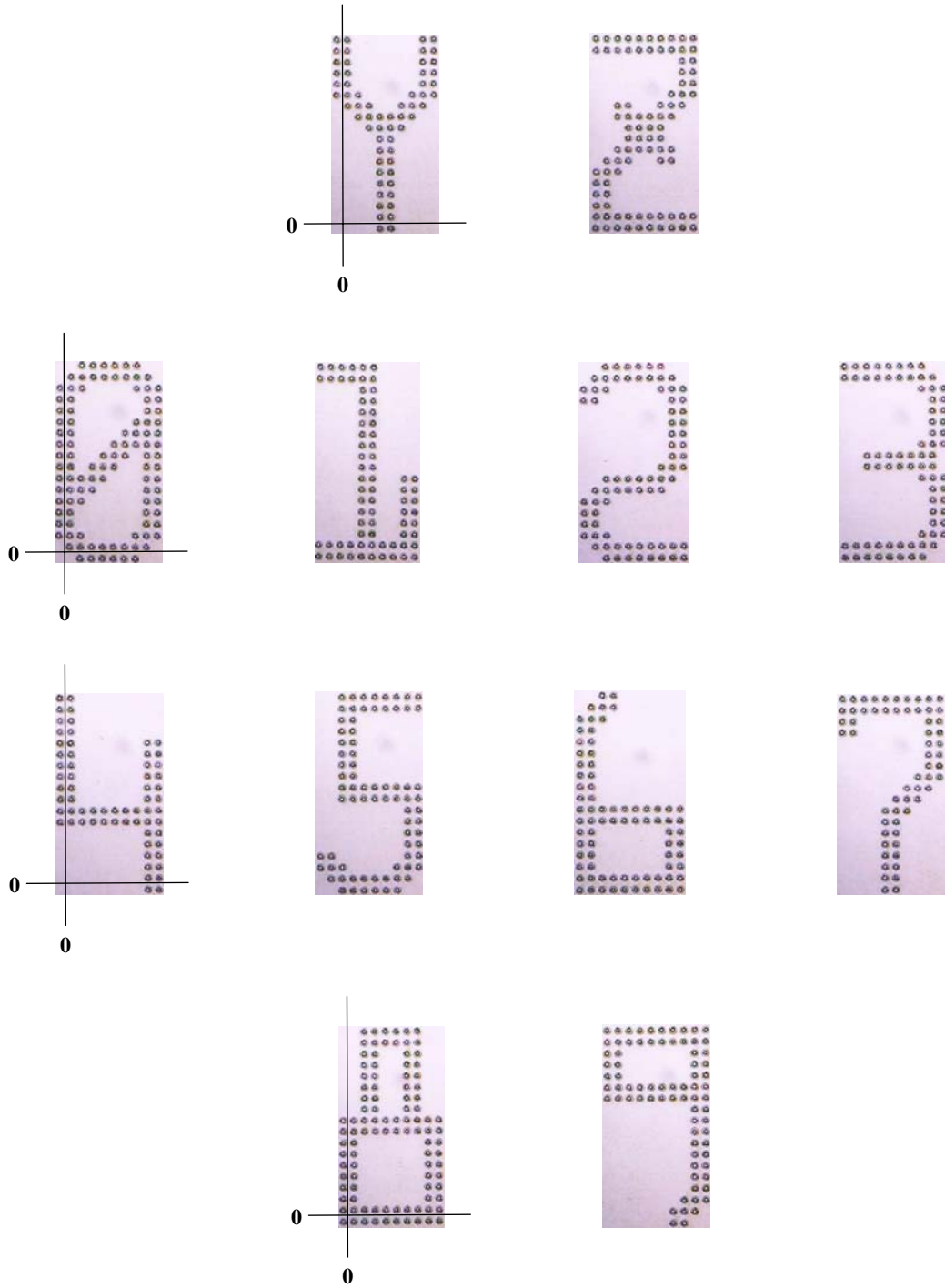


Figure 3
Double Density SEMI OCR Character Outlines



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